

实习证明

兹证明复旦大学微电子学院微电子科学与工程专业谢承臻同学(身份证号码: 310112200203205613)于 2023 年 9 月 19 日至 2024 年 7 月 31 日在我司芯片研发测试实验室实习。

该学生实习期间工作认真、善于思考,能够高效完成实习任务,在国家集成电路创新中心老师的指导下,设计了一款面向传感器应用的高 PSRR 的 LDO 芯片,并于实习期间完成了《一种芯片自动化测试系统 NICIC ATS》(计算机软件著作权登记号: 2024SR0964871)的开发。该学生与公司同事关系融洽,领导和共事员工都对该学生的表现予以充分肯定。

特此证明!

单位联系人: 邓磊

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国家集成电路创新中心

2024 年 7 月 31 日

Certificate of Internship

This is to certify that Chengzhen Xie, a student majoring in Microelectronics Science and Engineering at the School of Microelectronics, Fudan University (ID number: 310112200203205613), interned at our company's Chip R&D Test Lab from September 19, 2023 to July 31, 2024.

During the internship, this student worked diligently, demonstrated strong analytical skills, and efficiently completed the assigned tasks. During the internship, Chengzhen Xie developed the "NICIC ATS – An Automated Chip Testing System" (Software Copyright Registration Number: 2024SR0964871), and designed an LDO chip with high PSRR for sensor applications under guidance. Chengzhen Xie maintained excellent relationships with colleagues, and both the leadership and co-workers highly praised the student's performance.

Hereby certified!

Contact Person: Lei Deng

Tel: 18321839007

National Integrated Circuit Innovation Center (NICIC)

July 31, 2024